

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant:	Wen-Ching Chen	:	Group
Serial No:	10/662,433	:	Art Unit # 2878
Filed:	16 September 2003	:	Examiner:
Title:	CHIP SCALE PACKAGE STRUCTURE FOR AN IMAGE	:	D.J. Williams

AMENDMENT AFTER FINAL OFFICE ACTION

Mail Stop AF
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

Responsive to the Office Action dated 31 July 2006, please amend the above-referenced Patent Application as follows:

Amendments to the Claims are reflected in the Listing of Claims which begins on page 2 of this paper.

Remarks begin on page 7 of this paper.